SAMSUNG ELECTRO-MECHANICS

25-07019

RoHS+Halogen Compliant ecoparts

SPECIFICATION (Reference sheet)

- **Supplier : Samsung electro-mechanics**
- **Product : Multi-layer Ceramic Capacitor**
- **Samsung P/N : CL31A476MPHNNNE**
- **Description : CAP, 47㎌, 10V, ±20%, X5R, 1206**

A. Samsung Part Number

CL	31	A	476	M	P	H	N	N	N	E
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩	⑪

①	**Series**	Samsung Multi-layer Ceramic Capacitor			
②	**Size**	1206 (inch code)	L: 3.2 ± 0.2 mm	W: 1.6 ± 0.2 mm	
③	**Dielectric**	X5R	⑧	**Inner electrode**	Ni
④	**Capacitance**	47 ㎌		**Termination**	Cu
⑤	**Capacitance tolerance**	±20 %		**Plating**	Sn 100% (Pb Free)
			⑨	**Product**	Normal
⑥	**Rated Voltage**	10 V	⑩	**Special**	Reserved for future use
⑦	**Thickness**	1.6 ± 0.2 mm	⑪	**Packaging**	Embossed Type, 7"reel

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	120㎐±20% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at 150℃+0/-10℃, and maintained in ambient air for 24±2 hours.
Tan δ (DF)	0.1 max.	
Insulation Resistance	10,000Mohm or 100Mohm·㎌ Whichever is Smaller	Rated Voltage 60~120 sec.
Appearance	No abnormal exterior appearance	Visual inspection
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
Temperature Characteristics	X5R (From -55℃ to 85℃, Capacitance change should be within ±15%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g·F, for 10±1 sec.
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
Resistance to Soldering heat	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within ±5% Tan δ, IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)
Moisture Resistance	Capacitance change : within ±12.5% Tan δ : 0.125 max IR : 500Mohm or 12.5Mohm · μF Whichever is Smaller	With rated voltage 40±2℃, 90~95%RH, 500+12/-0hrs
High Temperature Resistance	Capacitance change : within ±12.5% Tan δ : 0.125 max IR : 1,000Mohm or 25Mohm · μF Whichever is Smaller	With 100% of the rated voltage Max. operating temperature 1000+48/-0hrs
Temperature Cycling	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	1 cycle condition Min. operating temperatur → 25℃ → Max. operating temperature → 25℃ 5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5℃, 10sec. Max)

⚠ Product specifications included in the specifications are effective as of March 1, 2013.
Please be advised that they are standard product specifications for reference only.
We may change, modify or discontinue the product specifications without notice at any time.
So, you need to approve the product specifications before placing an order.
Should you have any question regarding the product specifications,
please contact our sales personnel or application engineers.